

# **N-Channel Power MOSFET**

1000V, 1.85A, 8.5Ω

#### **FEATURES**

- 100% avalanche tested
- Advanced planar process
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

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- AC/DC LED Lighting
- **Power Supply**
- Power Meter

KEY PERFORMANCE PARAMETERS				
PARAMETER	PARAMETER VALUE UNIT			
$V_{DS}$	1000	V		
R <sub>DS(on)</sub> (max)	8.5	Ω		
$Q_g$	17	nC		









Notes: MSL 3 (Moisture Sensitivity Level) per J-STD-020

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	Limit	UNIT	
Drain-Source Voltage	V <sub>DS</sub>	1000	V	
Gate-Source Voltage	V <sub>GS</sub>	±30	V	
Continuous Drain Current (Note 1) $T_C = 25^{\circ}C$		1.85		
T <sub>C</sub> = 100°C	I <sub>D</sub>	1.16	A	
Pulsed Drain Current (Note 2)	I <sub>DM</sub>	7.4	А	
Total Power Dissipation @ T <sub>C</sub> = 25°C	P <sub>DTOT</sub>	77	W	
Single Pulse Avalanche Energy (Note 3)	E <sub>AS</sub>	20	mJ	
Single Pulse Avalanche Current (Note 3)	I <sub>AS</sub>	1.4	А	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	- 55 to +150	°C	

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	Limit	UNIT
Junction to Case Thermal Resistance	R <sub>eJC</sub>	1.62	°C/W
Junction to Ambient Thermal Resistance	R <sub>eJA</sub>	62	°C/W

Thermal Performance Note: ReJA is the sum of the junction-to-case and case-to-ambient thermal resistances. The casethermal reference is defined at the solder mounting surface of the drain pins. ReJA is guaranteed by design while ReCA is determined by the user's board design. R<sub>BJA</sub> shown below for single device operation on FR-4 PCB in still air.

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ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	МАХ	UNIT
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV <sub>DSS</sub>	1000			V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	$V_{GS(TH)}$	3.5	4.5	5.5	V
Gate Body Leakage	$V_{GS} = \pm 30 V$ , $V_{DS} = 0 V$	I <sub>GSS</sub>			±100	nA
Zero Gate Voltage Drain Current	$V_{DS} = 1000V, V_{GS} = 0V$	I <sub>DSS</sub>			1	μΑ
Drain-Source On-State Resistance (Note 4)	$V_{GS} = 10V, I_D = 0.9A$	R <sub>DS(on)</sub>		6	8.5	Ω
Dynamic (Note 5)	l		L			l
Total Gate Charge		Qg		17		
Gate-Source Charge	$V_{DS} = 800V, I_{D} = 1.85A,$	Q <sub>gs</sub>	(	5		nC
Gate-Drain Charge	$V_{GS} = 10V$	$Q_{gd}$		9		
Input Capacitance		C <sub>iss</sub>	-	625		
Output Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$	C <sub>oss</sub>	<i>J '</i>	38		pF
Reverse Transfer Capacitance	f = 1.0MHz	$C_{rss}$		15		
Gate Resistance	f = 1.0MHz, open drain	$R_g$		2.2		Ω
Switching (Note 6)						
Turn-On Delay Time		t <sub>d(on)</sub>		31		
Turn-On Rise Time	$V_{DD} = 500V, R_{G} = 25\Omega,$	t <sub>r</sub>		14		]
Turn-Off Delay Time	$I_D = 0.9A$ , $V_{GS} = 10V$	t <sub>d(off)</sub>		78		ns
Turn-Off Fall Time		t <sub>f</sub>		44		
Source-Drain Diode						
Forward Voltage (Note 4)	$I_S = 1.85A, V_{GS} = 0V$	$V_{SD}$			1.4	V
Reverse Recovery Time	$V_B = 100V, I_S = 1.85A$	t <sub>rr</sub>		359		ns
Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	Q <sub>rr</sub>		1.34		μC

#### Notes:

- 1. Current limited by package
- 2. Pulse width limited by the maximum junction temperature
- 3. L = 20mH,  $I_{AS}$  = 1.4A,  $V_{DD}$  = 50V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25 $^{\circ}C$
- 4. Pulse test: PW ≤ 300μs, duty cycle ≤ 2%
- 5. For DESIGN AID ONLY, not subject to production testing.
- 6. Switching time is essentially independent of operating temperature.

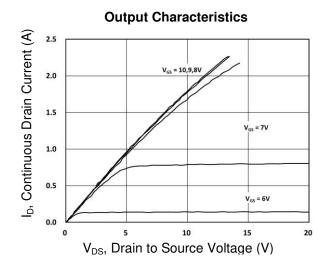
## **ORDERING INFORMATION**

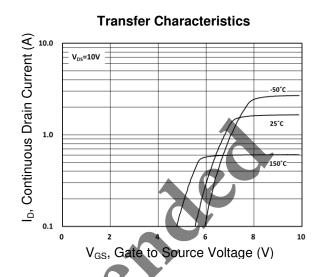
PART NO.	PACKAGE	PACKING
TSM2N100CP ROG	TO-252 (DPAK)	2,500pcs / 13" Reel

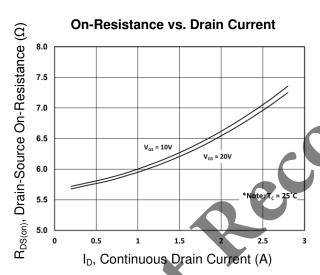


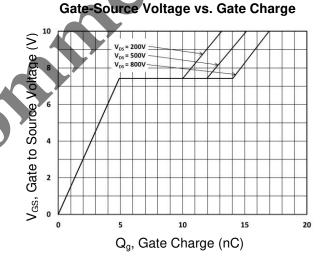
#### **CHARACTERISTICS CURVES**

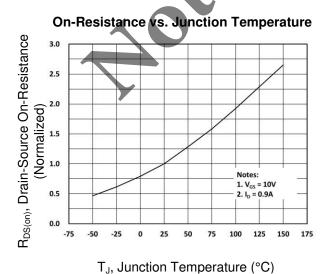
(T<sub>C</sub> = 25°C unless otherwise noted)

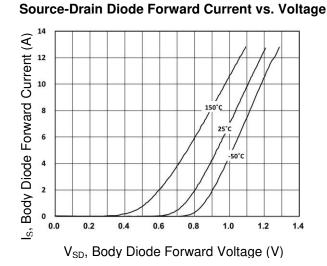












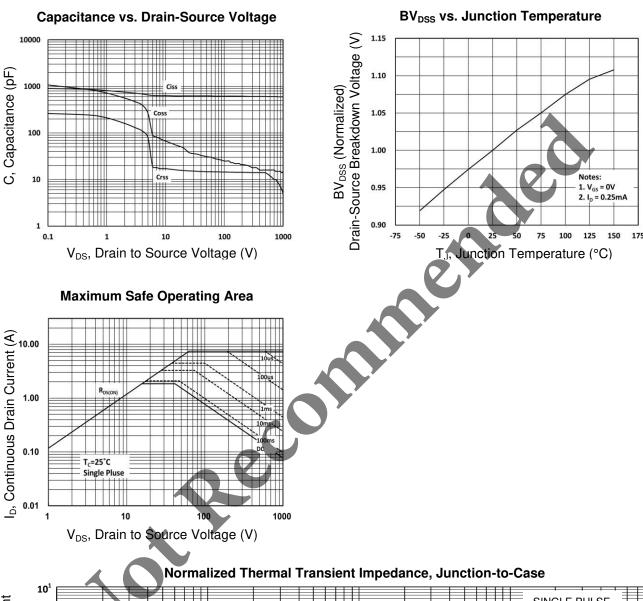
Version: A1606

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### **CHARACTERISTICS CURVES**

 $(T_C = 25^{\circ}C \text{ unless otherwise noted})$ 

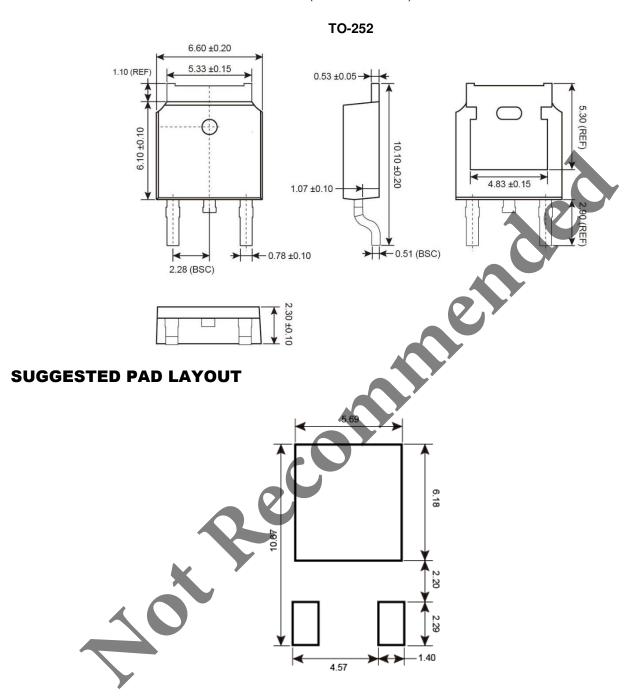


Normalized Effective Transient SINGLE PULSE R<sub>eJC</sub>=1.62°C/W Thermal Impedance 10° Duty=0.5 Duty=0.2 Duty=0.1 Duty=0.05 10 Notes: Duty=0.02  $Duty = t_1 / t_2$ Duty=0.01  $T_J = T_C + P_{DM} \times Z_{\Theta JC} \times R_{\Theta JC}$ Single pulse 10<sup>-3</sup> 10-1 10<sup>-3</sup> 10<sup>-2</sup> 10 10<sup>-4</sup>

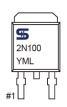
Square Wave Pulse Duration (s)



# PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)



# **MARKING DIAGRAM**



Y = Year Code

**M** = Month Code

O =Jan P =Feb Q =Mar R =Apr S =May T =Jun U =Jul V =Aug

W = Sep X = Oct Y = Nov Z = Dec

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**L** = Lot Code  $(1 \sim 9, A \sim Z)$ 





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